

AGENT TECHNOLOGIES, INC.
Legal Department, DL429
Intellectual Property Administration
P.O. Box 7599
Boulder, Colorado 80537-0599

PATENT APPLICATION

ATTORNEY DOCKET NO. 10031071-1

IN THE
UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s): Donald E. Schott, et al.

Serial No.: 10/769250

Examiner: Unknown

Filing Date: 1/30/04

Group Art Unit: Unk

Title: Method And Apparatus For High Electrical And Thermal Performance Ball Grid Array Package

COMMISSIONER FOR PATENTS
PO Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

This Information Disclosure Statement is submitted:

- (X) under 37 CFR 1.97(b), or
(Within three months of filing national application; or date of entry of national application; or before mailing date of first office action on the merits; whichever occurs last)
- () under 37 CFR 1.97(c) together with either a:
() Statement under 37 CFR 1.97(e), or
() a \$180.00 Processing fee under 37 CFR 1.17(p), or
(After the CFR 1.97 (b) time period, but before final action or notice of allowance, whichever occurs first)
- () under 37 CFR 1.97 (d) together with a:
() Statement under 37 CFR 1.97(e), and
() a \$180.00 processing fee under 37 CFR 1.17(p).
(Filed after final action or notice of allowance, whichever occurs first, but before payment of the issue fee)

Please charge to Deposit Account 50-1078 the sum of \$0.00. At any time during the pendency of this application, please charge any fees required or credit any overpayment to Deposit Account 50-1078 pursuant to 37 CFR 1.25.

() Applicant(s) submit herewith Form PTO 1449. References identified with an asterisk (*) were disclosed in Patent Application No. _____ filed _____, now U. S. Patent No. _____, and, as such, copies thereof are not included pursuant to the provisions of 37 CFR 1.98(d).

() A concise explanation of the relevance of foreign language patents, foreign language publications and other foreign language information listed on PTO Form 1449, as presently understood by the individuals(s) designated in 37 CFR 1.56 (c) most knowledgeable about the content is given on the attached sheet, or where a foreign language patent is cited in a search report or other action by a foreign patent office in a counterpart foreign application, an English language version of the search report or action which indicates the degree of relevance found by the foreign office is listed on form PTO 1449 and is enclosed herewith.

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, PO Box 1450, Alexandria, VA 22313-1450.

Date of Deposit: 2/25/04

Typed Name: Sue A. Hebert

Signature: Sue A. Hebert

Respectfully submitted,

Donald E. Schott, et al.

By Cynthia S. Mitchell

Cynthia S. Mitchell

Attorney/Agent for Applicant(s)

Reg. No. 36,081

Date: 2/25/04



PATENT APPLICATION

Sheet 1 of 1

FORM PTO-1449

ATTY. DOCKET NO.

10031071-1

SERIAL NO.

10/769,250

LIST OF PATENTS AND PUBLICATIONS FOR
APPLICANT'S INFORMATION DISCLOSURE
STATEMENT

APPLICANT

Donald E. Schott, et al.

FILING DATE

1/30/04

GROUP

Unk

(Use several sheets if necessary)

REFERENCE DESIGNATION

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	*	DOCUMENT NUMBER	DATE	NAME
		6,108,212	8/22/00	Lach, et al.
		6,132,543	10/17/00	Mohri, et al.

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	NAME	TRANSLATION	
					YES	NO

OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, etc.)

X	Tongbi Jiang, et al., Composite Interposer For BGA Packages, US2003/0164556 A1 Published 9/4/2003.
X	Binng Y. Lao, et al., Single And Multiple Layer Packaging Of High-Speed/High-Density ICS, US2003/0096447 A1 published 5/22/03.
X	Chung Wen Ho, High Density Cavity-Up Wire Bond, US2001/0046725 A1 Published 11/29/01.

EXAMINER

DATE CONSIDERED

* Copies of these references are not enclosed pursuant to 37 CFR 1.98(d). (See accompanying IDS)